Electronic Version v1.1

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SUBMISSION TYPE:			NEW ASSIGNMENT	
NATURE OF CONVEYANCE:			ASSIGNMENT	
CONVEYING PARTY DATA				
N			ame	Execution Date
Hsien-Kun Chiu				05/30/2007
Chin-Chuan Lai				05/30/2007
Yi-Pen Lin				05/30/2007
Shu-Chen Yang				05/30/2007
RECEIVING PARTY DATA				
Name:	Chunghwa Picture Tubes, LTD.			
Street Address:	No. 22, Sec. 3, Chungshan N Rd.			
City:	Taipei	aipei		
State/Country:	TAIWAN			
PROPERTY NUMBERS Total: 1 Property Type Number Number: 11761374				
Application Number: 11761		17613	374 Number	
CORRESPONDENCE DATA				
CORRESPONDENCE DATAFax Number:(949)660-0809Correspondence will be sert via US Mail when the fax attempt is unsuccessful.Phone:886223692800Email:usa@jcipgroup.com.twCorrespondent Name:JIANQ CHYUN INTELLECTUAL PROPERTY OFFICEAddress Line 1:7F1, NO. 100, ROOSEVELT RD., SEC. 2,Address Line 4:Taipei, TAIWAN				
ATTORNEY DOCKET NUMBER:			22316-US-PA	
NAME OF SUBMITTER:			Belinda Lee	
Total Attachments: 2 source=22316assignment#page1.tif source=22316assignment#page2.tif				
500306678 REEL: 019502 FRAME: 0270				

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ASSIGNMENT

WHEREAS,

1. Chiu, Hsien-Kun

2. Lai, Chin-Chuan

3. Lin, Yi-Pen

4. Yang, Shu-Chen

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: METHOD FOR FABRICATING CONDUCTIVE LAYER

[] Filed:

Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, Chunghwa Picture Tubes, LTD. of No. 22, Sec. 3, Chungshan N Rd., Taipei, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

PATENT REEL: 019502 FRAME: 0271 067161IUS 22316-US-PA

ASSIGNMENT CONTINUED

-2-

Date:

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

sien - 1 Signature:

Sole or First Joint Inventor: Hsien-Kun Chiu

Signature: Chin - Chuan Lai

Second Joint Inventor (if any): Chin-Chuan Lai

Yi-Pen Lin Signature:

Third Joint Inventor (if any): Yi-Pen Lin

Shy-Chen Yang Signature:

Fourth Joint Inventor (if any): Shu-Chen Yang

Date: May 30, 2007

May 30, 2007

Date: May 30, 2007

Date: <u>May 30, 2007</u>

RECORDED: 06/30/2007

PATENT REEL: 019502 FRAME: 0272